

# Specification for Approval

DEVICE NUMBER: BPT-HP735A-TRB

SAMPLES ATTACHED AREA

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| 2015.08.21   | 1.0 | 1.0 | 1.0 | 1.0 | 1.0 | 1.0 | 1.0 | 1.0 |  | Initial Released |
|              |     |     |     |     |     |     |     |     |  |                  |
|              |     |     |     |     |     |     |     |     |  |                  |
|              |     |     |     |     |     |     |     |     |  |                  |
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|              |     |     |     |     |     |     |     |     |  |                  |

### FOR CUSTOMER'S APPROVAL STAMP OR SIGNATURE

| APPROVED | PURCHASE | MANUFACTURE | QUALITY | ENGINEERING |
|----------|----------|-------------|---------|-------------|
|          |          |             |         |             |
|          |          |             |         |             |
|          |          |             |         |             |
|          |          |             |         |             |

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### Description

The BPT-HP735A-TRB is a silicon NPN phototransistor detector in a 0805 SMD type package.

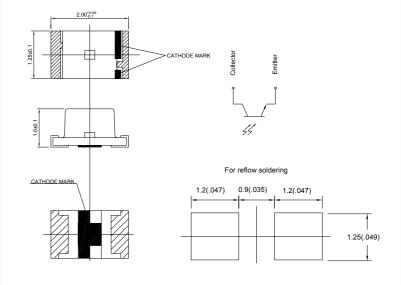
#### •Features:

- 1. Wide range of collector current.
- 2. Lend for high sensitivity.
- 3. Low cost plastic package.
- 4. Lens Appearance: Water Clear.

### Applications:

- 1. Smoke Detector
- 2. Automatic Control System
- 3. Any design requiring sensitivity and stable characteristics.

## ●Package Dimensions:



### NOTES:

- 1.All dimensions are in millimeters (inches).
- 2.Tolerance is ±0.10mm (0.004") unless otherwise specified.
- 3. Specifications are subject to change without notice.

## ● Absolute Maximum Ratings(Ta=25°C)

| Parameter                           | Symbol            | Rating     | Unit |
|-------------------------------------|-------------------|------------|------|
| Power Dissipation                   | Pd                | 100        | mW   |
| Emitter-Collector Breakdown Voltage | BV <sub>CEO</sub> | 50         | V    |
| Emitter-Collector Breakdown Voltage | $BV_{ECO}$        | 5          | V    |
| Operating Temperature               | Topr              | -40°C~85°C | -    |
| Storage Temperature                 | Tstg              | -40°℃~85°℃ | -    |
| Soldering Temperature               | Tsol              | See Page6  | -    |



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# ■ Electrical and optical characteristics(Ta=25°C)

| Parameter               | Symbol            | Condition   | Min.  | Тур.  | Max. | Unit |
|-------------------------|-------------------|---|-------|-------|------|------|
| Spectrum Sensitivity    | λ                 | IF=50mA   | 500   | ı     | 1000 | nm   |
| Short Circuit Current   | λр                | IF=50mA   | 1     | 940   | -    | nm   |
| Collector Light Current | $I_{C(ON)}$       | V <sub>CE</sub> =5V, λp=940nm,<br>H=1.0mw/cm <sup>2</sup> | 1.156 | 3.0   | ı    | mA   |
| Collector Dark Current  | $I_{CEO}$         | V <sub>CE</sub> =20V                                      | ı     | ı     | 100  | nA   |
| Rise/Fall Time          | Tr/Tf             | $V_{CE}$ =5V, Ic=1mA, $R_L$ =1 $K\Omega$                  | -     | 25/25 | ı    | us   |
| Viewing Angle           | 2θ <sub>1/2</sub> | -   | -     | 120   | -    | deg  |

## Typical Electro-Optical Characteristics Curves

Fig.1 Collector current vs Collector emitter voltage

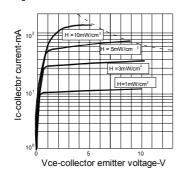


Fig.2 Ambient temperature vs.Collector Dissipantic

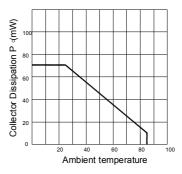


Fig.3 Dark current vs Free-air temperature

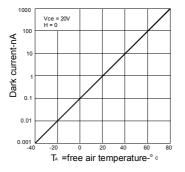
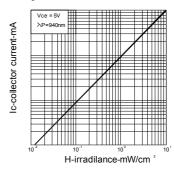
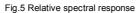
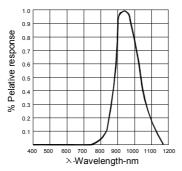
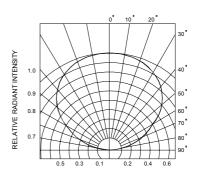


Fig.4 Collector current vs Irradlance





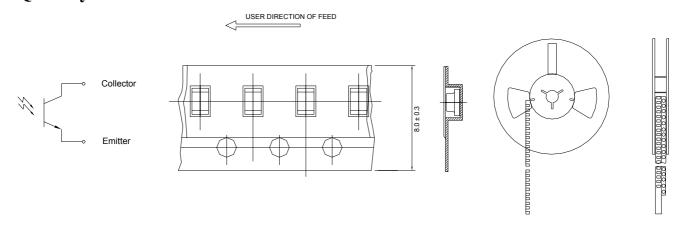




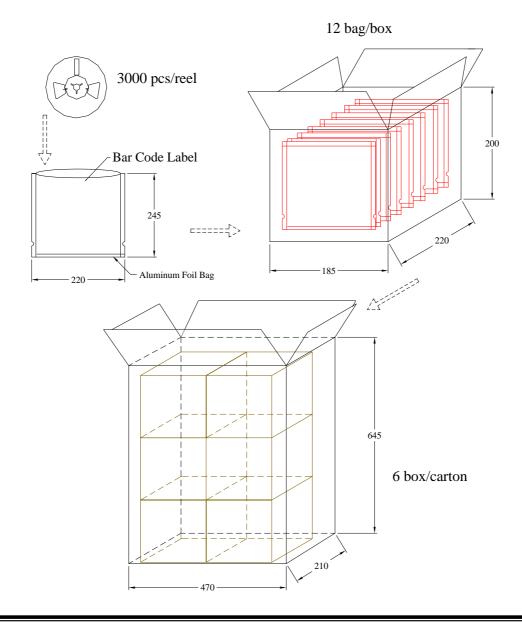


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# ■ Tapping and packaging specifications(Units: mm) Quantity:1000-3000PCS



## ● Package Method: (unit:mm) Vacuum





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### Bin Limits:

Collector Light Current Bin Limits( $V_{CE}=5V$ , H=1.0mw/cm $^2$ ,  $\lambda$  p=940nm)

| BIN CODE | I <sub>C(ON)</sub> (mA) |       |  |  |
|----------|-------------------------|-------|--|--|
| BIN CODE | Min                     | Max   |  |  |
| K        | 1.156                   | 1.665 |  |  |
| L        | 1.665                   | 2.398 |  |  |
| M        | 2.398                   | 3.455 |  |  |
| N        | 3.455                   | 4.976 |  |  |
| Р        | 4.976                   | 7.165 |  |  |

Tolerance for each Bin limit is ± 15%.

| ● BIN : <u>x</u> |                                  |
|------------------|----------------------------------|
| <b>↑</b>         |                                  |
|                  |                                  |
|                  | Collector Light Current Bin Code |



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# Reliability Test

| Classification | Test Item                                       | Reference Standard   | Test Conditions   | Result |
|----------------|---|--|---|--------|
|                | Operation Life                                  | MIL-STD-750D:1026<br>MIL-STD-883D:1005<br>JIS-C-7021 :B-1                      | Ta: Under room temperature Test time:1,000hrs IF=Product Recommended IF | 0/32   |
| Endurance      | High<br>Temperature<br>High Humidity<br>Storage | MIL-STD-202F:103B<br>JIS-C-7021 :B-11  | Ta:85±5℃<br>RH:90%-95%<br>Test time:240hrs                              | 0/32   |
| Test           | High<br>Temperature<br>Storage                  | MIL-STD-883:1008<br>JIS-C-7021 :B-10   | Ta:100±5℃<br>Test time:1,000hrs   | 0/32   |
|                | Low<br>Temperature<br>Storage                   | JIS-C-7021 :B-11   | Ta: -40±5°C<br>Test time=1,000hrs                                       | 0/32   |
|                | Temperature<br>Cycling                          | MIL-STD-202F:107D<br>MIL-STD-750D:1051<br>MIL-STD-883D:1010<br>JIS-C-7021 :A-2 | Ta:-35±5°C ~25±5°C ~85±5°C ~25±5°C 30min 5min 30min 5min                | 0/32   |
| Environmental  | Thermal Shock                                   | MIL-STD-202F:107D(1980)<br>MIL-STD-750D:1051(1995)<br>MIL-STD-883D:1011(1991)  | 10min 10 min  | 0/32   |
| Test           | Wetting<br>balance                              | MIL-STD-883:2003<br>MIL-STD-202F:208D<br>MIL-STD-883D:2003                     | Ta:230±5°ℂ<br>Time:5±0.5s   | 0/32   |
|                | Solder<br>Resistance                            | MIL-STD-202F:210A<br>MIL-STD-883D:1011<br>JIS-C-7021 :A-1                      | Ta:260±10°ℂ<br>Time:10±1s   | 0/32   |

# Judgment criteria of failure for the reliability

| Measuring items    | Symbol              | Measuring conditions | Judgment criteria for failure |
|--------------------|---------------------|----------------------|-------------------------------|
| Forward voltage    | V <sub>F</sub> (V)  | I <sub>F</sub> =50mA | Initial Level*1.1             |
| Reverse current    | I <sub>R</sub> (uA) | V <sub>R</sub> =5V   | Over U*2                      |
| Luminous intensity | Iv ( mcd )          | I <sub>F</sub> =50mA | Initial Level*0.7             |

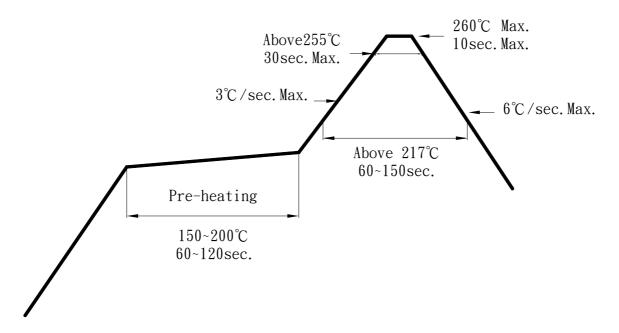
Note: 1.U means the upper limit of specified characteristics.

2.Measurment shall be taken between 2 hours and after the test pieces have been returned to normal ambient conditions after completion of each test.



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## **●IR-Reflow Soldering**

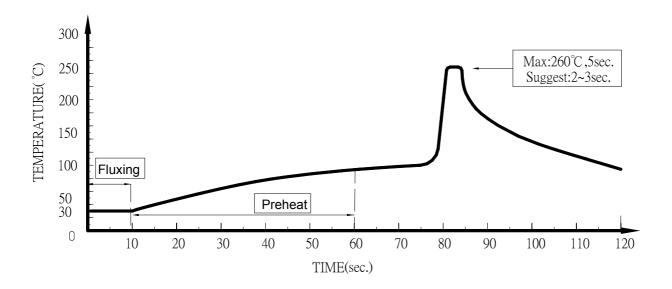


- 1. Avoid any external stress applied to the resin while the LEDs are at high temperature, especially during soldering.
- 2. Avoid rapid cooling or any excess vibration during temperature ramp-down process
- Although the soldering condition is recommended above, soldering at the lowest possible temperature is feasible for the LEDs



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## Dip Soldering



- 1. Please avoid any external stress applied to the lead-frames and epoxy while the LEDs are at high temperature, especially during soldering
- 2. DIP soldering and hand soldering should not be done more than one time.
- 3. After soldering, avoid the epoxy lens from mechanical shock or vibration until the LEDs are back to room temerature.
- 4. Avoid rapid cooling during temperature ramp-down process
- 5. Although the soldering condition is recommended above, soldering at the lowest possible temperature is feasible for the LEDs

#### IRON Soldering

300 $^{\circ}$  Within 3 sec.,One time only.



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## Notes for designing:

Care must be taken to provide the current limiting resistor in the circuit so as to drive the BRIGHT LEDs within the rated figures. Also, caution should be taken not to overload BRIGHT LEDs with instantaneous voltage at the turning ON and OFF of the circuit.

When using the pulse drive care must be taken to keep the average current within the rated figures. Also, the circuit should be designed so as be subjected to reverse voltage when turning off the BRIGHT LEDs.

### Storage:

In order to avoid the absorption of moisture, it is recommended to solder BRIGHT LEDs as soon as possible after unpacking the sealed envelope.

If the envelope is still packed, to store it in the environment as following:

- (1) Temperature :  $5^{\circ}$ C  $30^{\circ}$ C ( $41^{\circ}$ F)Humidity : RH 60% Max.
- (2) After this bag is opened, devices that will be applied to infrared reflow, vapor-phase reflow, or equivalent soldering process must be:
- a. Completed within 168 hours.
- b. Stored at less than 30% RH.
- (3) Devices require baking before mounting, if: (2) a or (2) b is not met.
- (4) If baking is required, devices must be baked under below conditions: 48 hours at  $60^{\circ}\text{C} \pm 3^{\circ}\text{C}$ .

### Package and Label of Products:

- (1) Package: Products are packed in one bag of 3000 pcs (one taping reel) and a label is attached on each bag.
- (2) Label:

